

Supplementary Material

Phase Interface Engineering of Rich-Defects 1T/2H-WX₂/RGO (X=S, Se) Nanosheets for Efficient Microwave Absorber and Supercapacitor Applications

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The relationship ε' and ε'' can be expressed as formula S1 and S2 for further analyzed to clarify the dielectric loss mechanism:

$$(\varepsilon' - \varepsilon_\infty)^2 + (\varepsilon'')^2 = (\varepsilon_s - \varepsilon_\infty)^2 \quad (S1)$$

$$\varepsilon'' = \varepsilon_p'' + \varepsilon_c'' = \frac{\varepsilon_s - \varepsilon_\infty}{1 + \omega^2 \tau^2} \omega \tau + \frac{\sigma}{\omega \varepsilon_0} \quad (S2)$$

Among them, ε_s is the relative dielectric constant at static state, ε_∞ is the relative dielectric constant at high frequency, ε_0 is the vacuum dielectric constant, ω is the angular frequency, τ is the relaxation time, and σ is the conductivity. Among, ε'' can be divided into the conduction loss (ε_c'') and polarization relaxation loss (ε_p''), respectively.

The reflection loss (RL) is calculated by transmission line theory according to formula (S3) and formula (S4):

$$RL(dB) = 20 \lg \left| \frac{Z_{in} - Z_0}{Z_{in} + Z_0} \right|$$

(S3)

$$Z_{in} = Z_0 \sqrt{\frac{\mu_r}{\varepsilon_r} \tanh(j \frac{2\pi f d}{c} \sqrt{\mu_r \varepsilon_r d})}$$

(S4)

In the formula, Z_0 represents the free space impedance, Z_{in} denotes the input characteristic impedance, f is the microwave frequency, d refers to the thickness of absorber and c is the speed of light. When $RL < -10$ dB, it means that more than 90 % of the electromagnetic waves are absorbed by the absorber.

The quarter-wavelength matching theory can be described as formula S5:

$$t_m = \frac{n\lambda}{4} = \frac{nc}{4f_m(|\varepsilon_r||\mu_r|)} (n = 1, 3, 5 \dots)$$

(S5)

In the above formula, t_m represents the matching thickness when reaching RL_{\min} , and f_m represents the corresponding frequency.

The attenuation constants (α) and impedance matching (Z) can be calculated by formulas (S6) and (S7):

$$\alpha = \frac{\sqrt{2}\pi f}{c} \times \sqrt{(\mu''\varepsilon'' - \mu'\varepsilon')^2 + (\mu''\varepsilon'' + \mu'\varepsilon')^2 + (\mu'\varepsilon'' + \mu''\varepsilon')^2}$$

(S6)

$$Z = \frac{Z_{in}}{Z_0} = \frac{\sqrt{(\mu''^2 + \mu'^2)}}{\sqrt{(\varepsilon''^2 + \varepsilon'^2)}}$$

(S7)

The specific capacitance (C_m) was calculated from the GCD results using the following formula S8:

$$C_m = (I\Delta t)/(m\Delta V)$$

(

S

8)

Among them, I and Δt represent the test current (A) and discharge time (s), m and ΔV represent the mass of active material (g) and voltage window (V), respectively.

The capacitance control and diffusion control ratios can be quantitatively calculated by the following formula (S9):

$$i(v) = k_1 v + k_2 \quad (S9)$$

Where i , v , k_1 , and k_2 , represent the output current, scan rate, and two constants, respectively.

Energy density (E , Wh/kg) and power density (P , W/kg) were calculated by formulas (S10) and (S11):

$$E = \frac{C\Delta V}{7.2}$$

(S10)

$$p = 3600 \frac{E}{\Delta t} \quad (\text{S11})$$

where C is specific capacitance (F/g), ΔV is the operating potential window (V) and Δt is discharge time (s).

Table S1. The microwave absorption properties of TMDs-based absorbing materials reported in the literature were compared.

Samples	Thickness (mm)	RL _{min} (dB)	EAB (GHz)	Filler Loading (wt%)	References
1T/2H-WS ₂ /RGO-15	2.60	-45.69	7.68	5	This work
1T/2H-WSe ₂ /RGO-4	2.60	-35.26	7.04	5	This work
MoSe ₂ @rGO hybrids	2.32	-68.70	5.04	60	[1]
MoSe ₂ @RGO	7.56	-22.8	3.86	40	[2]
1T@2H-MoS ₂ /RGO	2.50	-66.77	4.00	30	[3]
RGO/MoSe ₂ VDWH	6.29	-65.34	4.20	30	[4]
Carbon nanofibers/MoSe ₂	3.06	-53.33	4.04	20	[5]
Fe ₃ O ₄ /MoS ₂ /rGO/Ti ₃ C ₂ T _x	3.61	-66.92	6.08	5	[6]
WS ₂ -rGO	2.70	-41.5	3.50	40	[7]

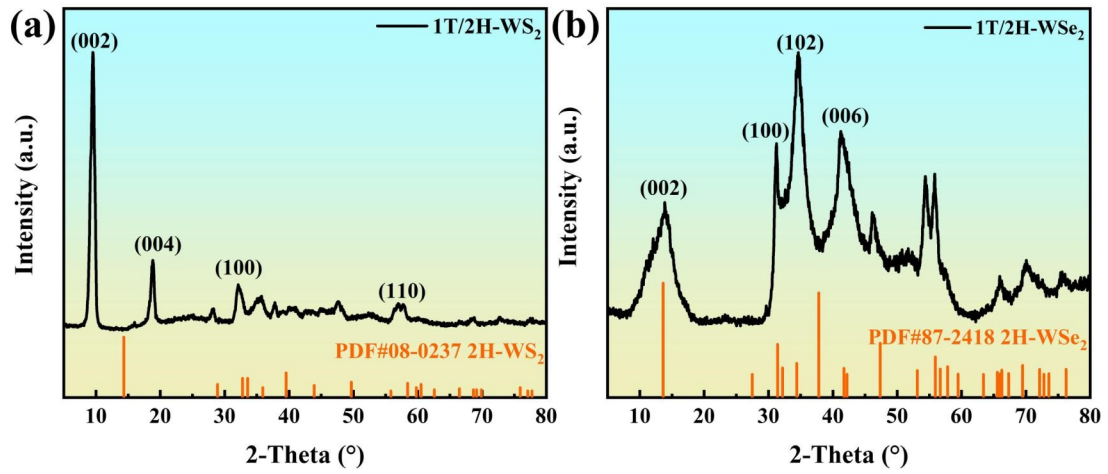


Fig. S1. (a, b) XRD spectrum of 1T/2H-WS₂ and 1T/2H-WSe₂.

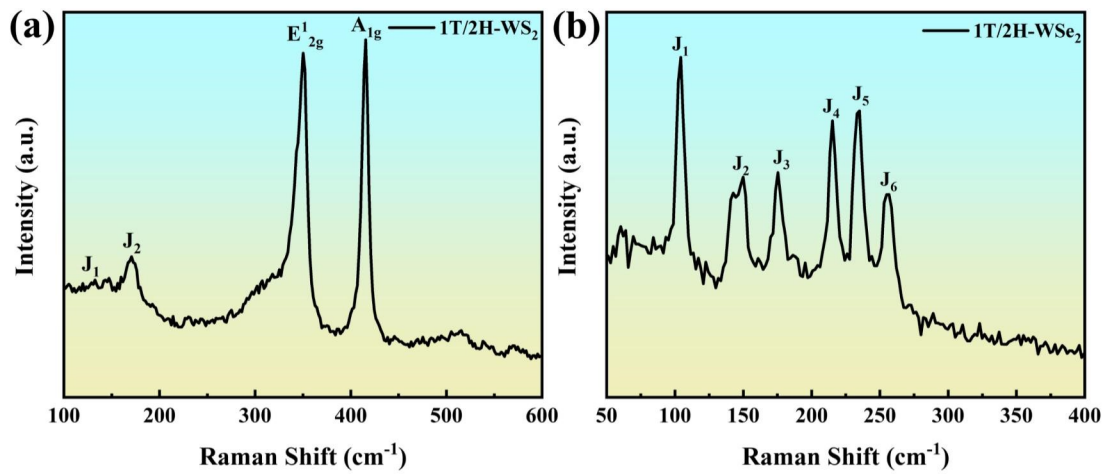


Fig. S2. (a, b) Raman images of 1T/2H-WS₂ and 1T/2H-WSe₂.

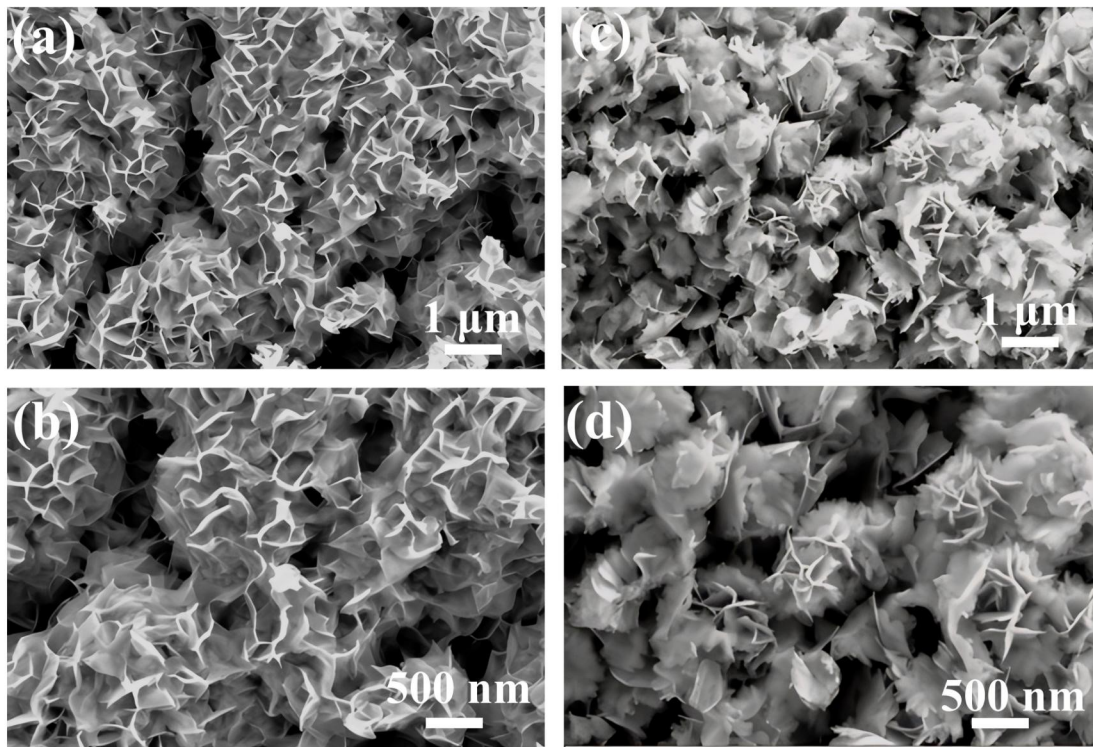


Fig. S3. SEM images of (a, b) 1T/2H-WS₂ and (c, d) 1T/2H-WSe₂.

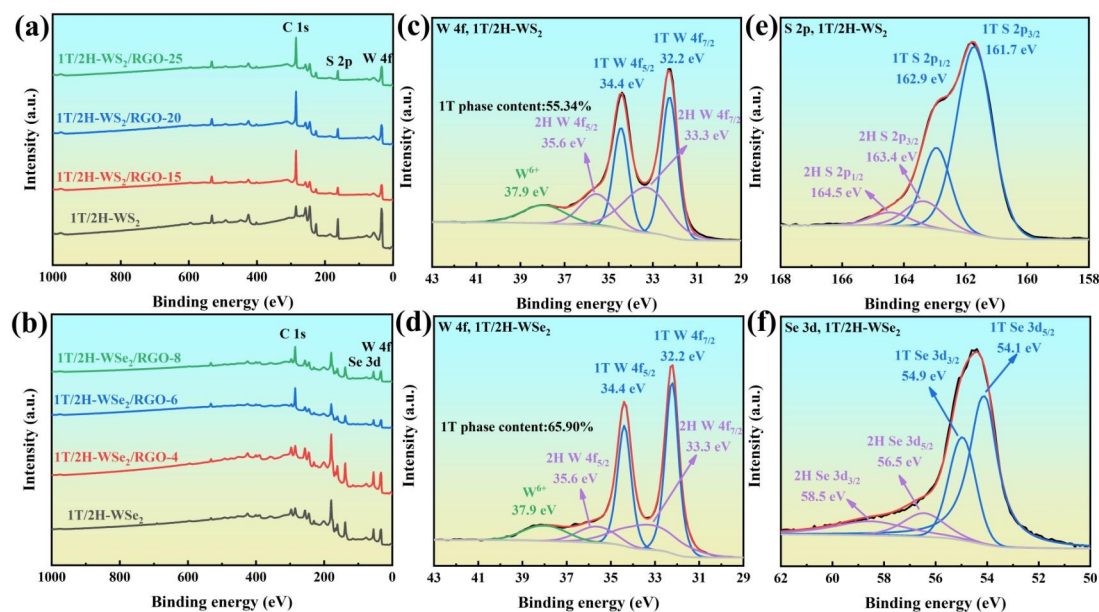


Fig. S4. The XPS survey spectra of (a) 1T/2H-WS₂/RGO and (b) 1T/2H-WSe₂/RGO, the high-resolution XPS of W 4f in (c) 1T/2H-WS₂ and (d) 1T/2H-WSe₂, the high-resolution XPS of (e) S 2p in 1T/2H-WS₂ and (f) Se 3d in 1T/2H-WSe₂.

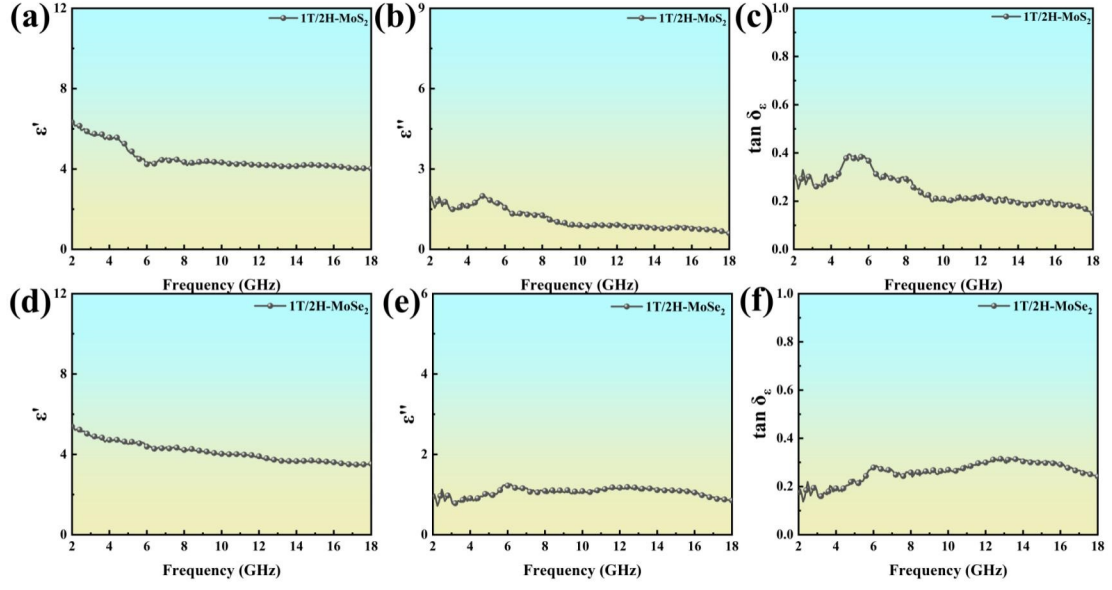


Fig. S5. Dielectric parameters of 1T/2H-WS₂ and 1T/2H-WSe₂ in the frequency range of 2-18 GHz: (a, d) ϵ' , (b, e) ϵ'' , and (c, f) $\tan \delta_\epsilon$.

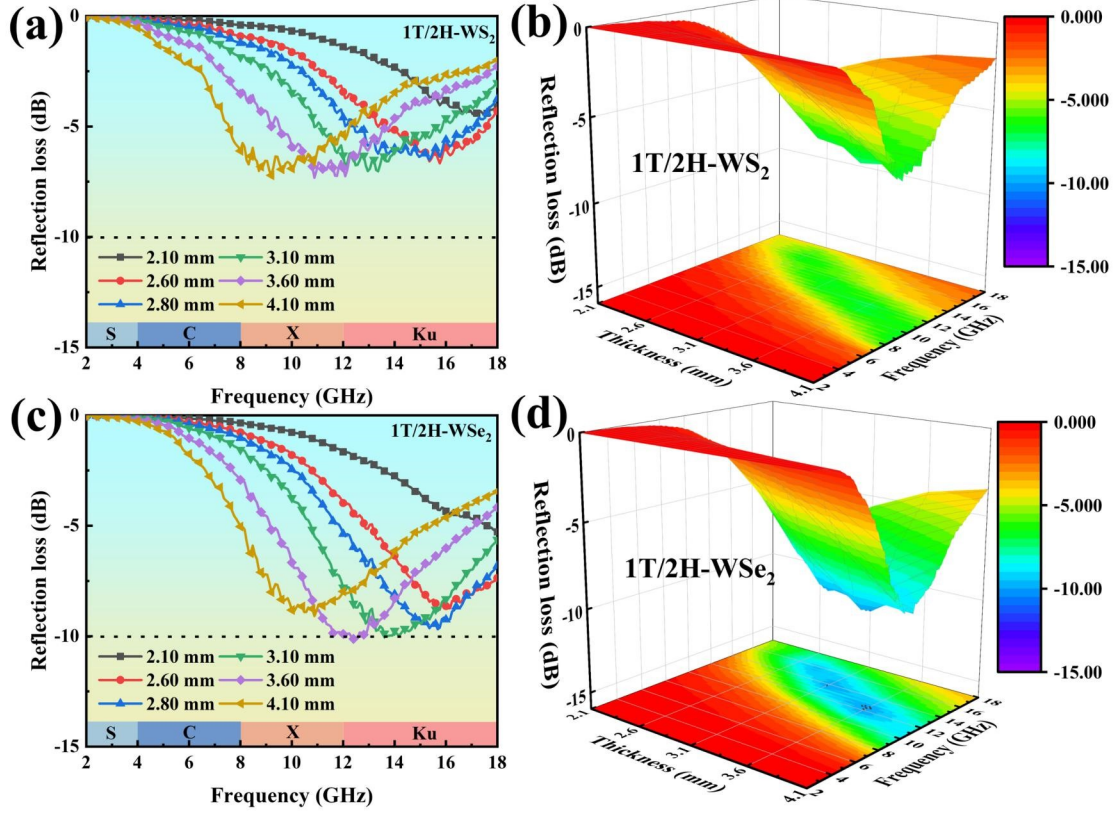


Fig. S6. The electromagnetic wave absorption properties of 2D and 3D RL curves plots of (a, b) 1T/2H-WS₂ and (c, d) 1T/2H-WSe₂.

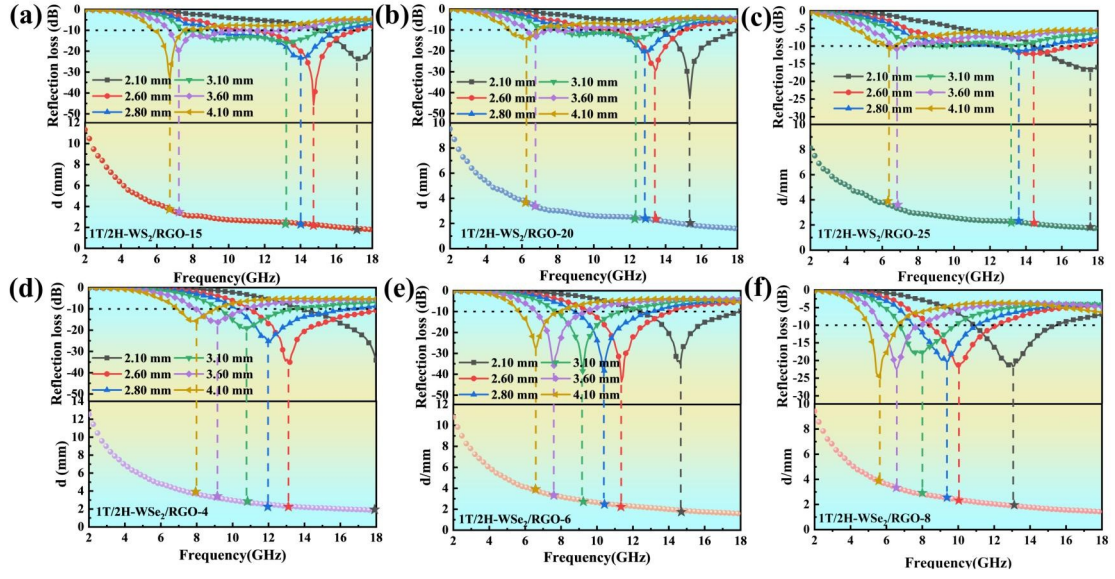


Fig. S7. The RL_{\min} value and the quarter-wavelength matching of (a-c) 1T/2H-WS₂/RGO and (d-f) 1T/2H-WSe₂/RGO.

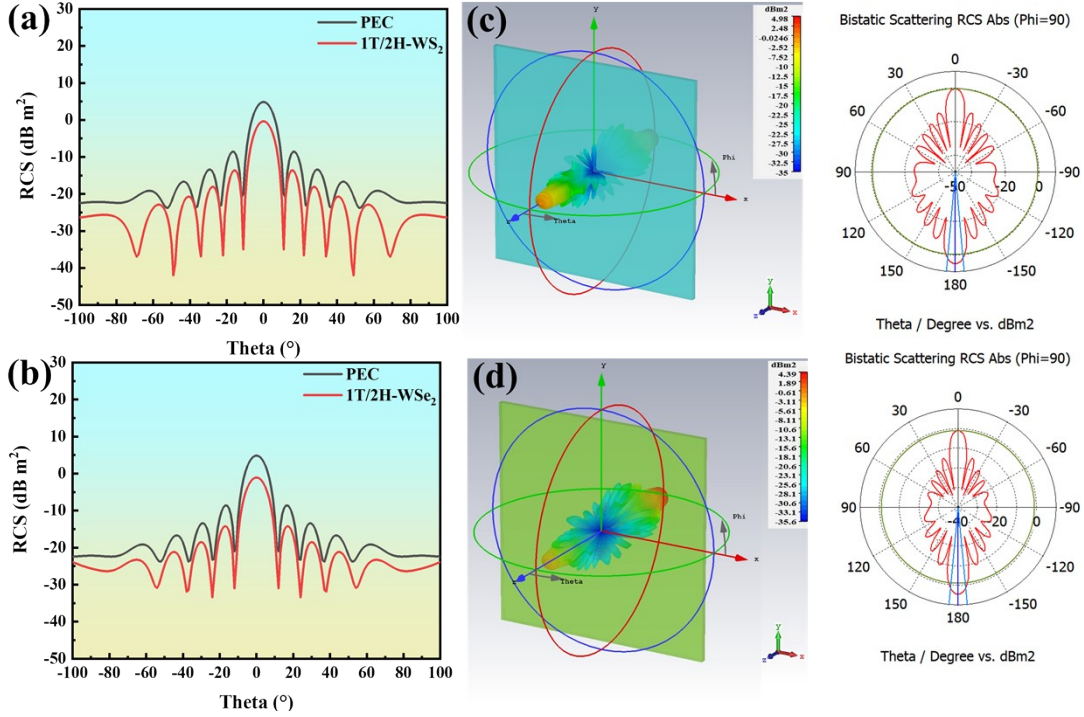


Fig. S8. (a, b) RCS reduction values of PEC and 1T/2H-WX₂ at different angles, (c, d) 3D and 1D RCS distribution for the PEC substrates covered with 1T/2H-WX₂.

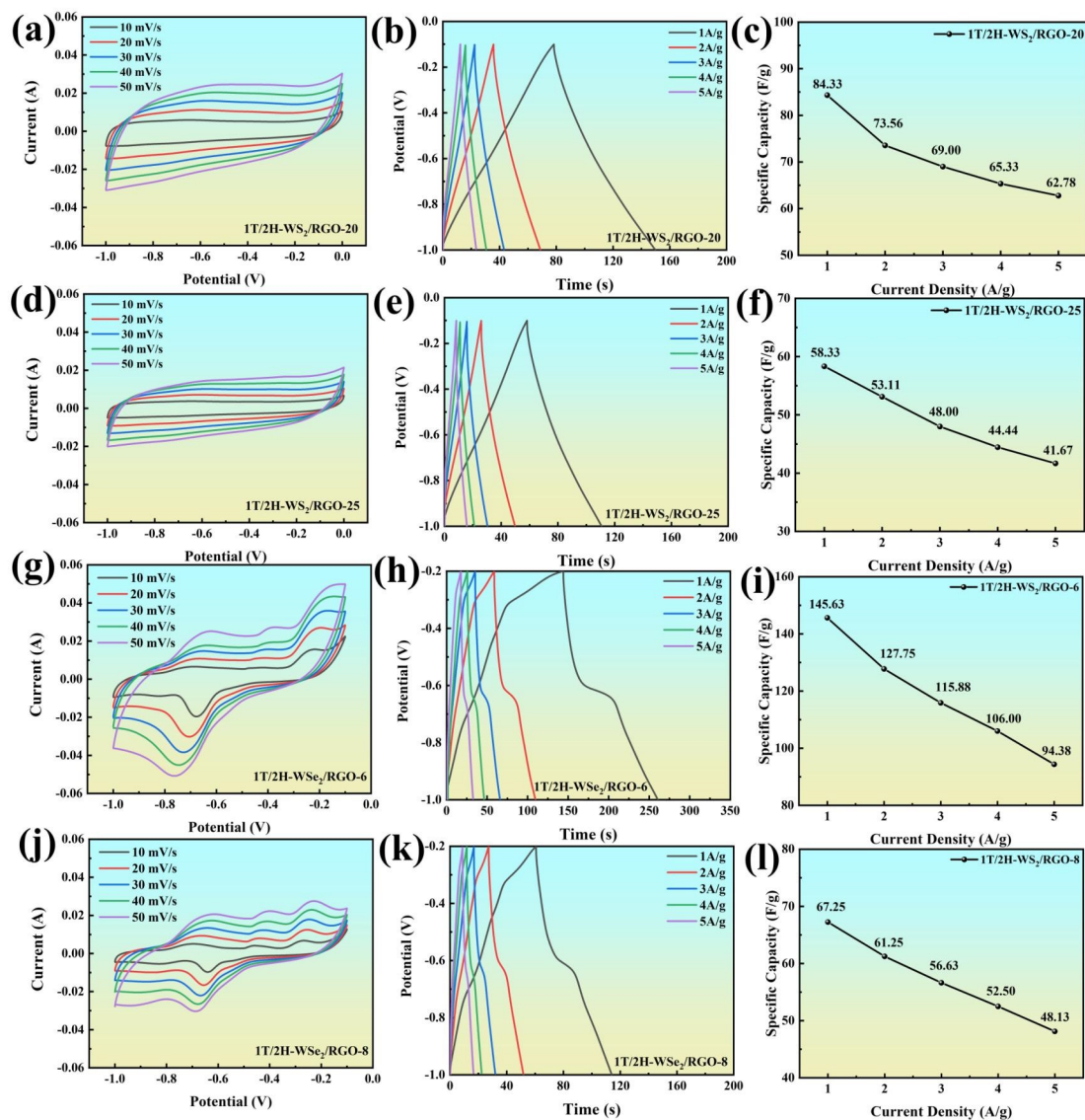


Fig. S9. CV curves, GCD curves, and specific capacitance at different current densities calculated from GCD test of (a-c) 1T/2H-WS₂/RGO-20, (d-f) 1T/2H-WS₂/RGO-25, (g-i) 1T/2H-WSe₂/RGO-6, and (j-l) 1T/2H-WSe₂/RGO-8.

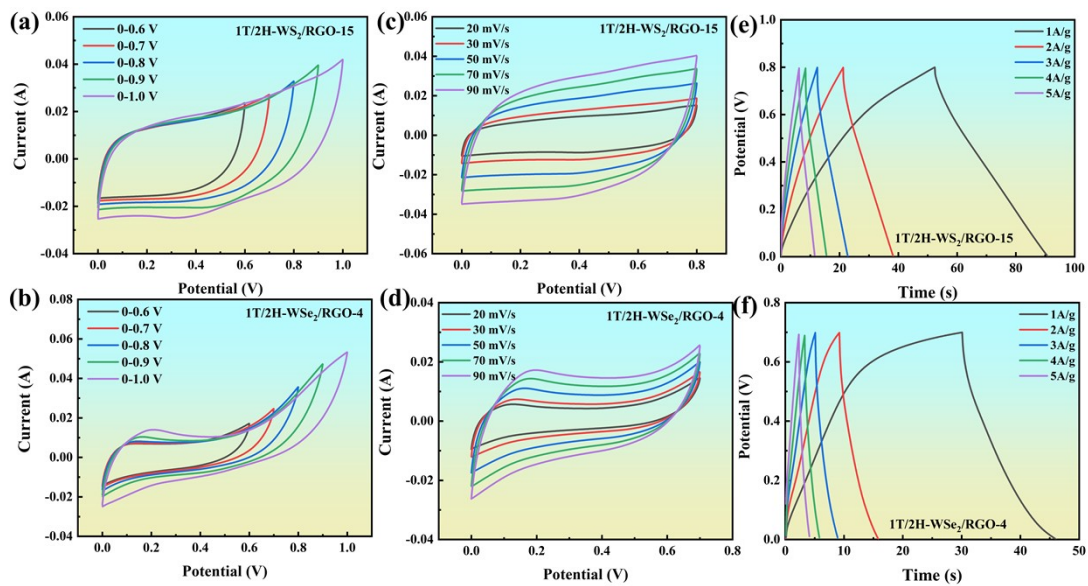


Fig. S10. (a, b) Voltage windows, (c, d) CV curves, and (e, f) GCD curves of assembled symmetrical supercapacitors of 1T/2H-WS₂/RGO-15 and 1T/2H-WS₂/RGO-4.

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